



#### **Product Summary**

Device	BVDSS	RDS(ON) Max	ID T <sub>A</sub> = +25°C
Q1	100V	220mΩ @ V <sub>GS</sub> = 10V	1.7A
N-Channel	100 V	260mΩ @ V <sub>GS</sub> = 4.5V	1.6A
Q2	Q2 -100V	250mΩ @ VGs = -10V	-1.7A
P-Channel	-1000	$300m\Omega @ V_{GS} = -4.5V$	-1.6A

#### **Features and Benefits**

- 100% Unclamped Inductive Switch (UIS) Test in Production
- Low Input Capacitance
- Low On-Resistance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. <u>https://www.diodes.com/quality/product-definitions/</u>

#### **Description and Applications**

This new generation MOSFET has been designed to minimize the onstate resistance ( $R_{DS(ON)}$ ) yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- DC-DC Converters
- Power Management Functions
- Backlighting

Pin1

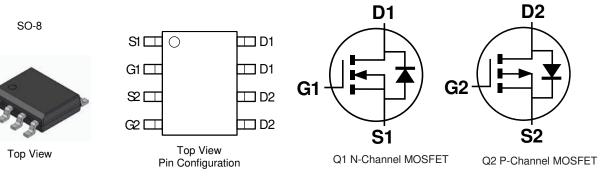
Notes:

# Mechanical Data

Package: SO-8

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- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Tin Finish Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.074 grams (Approximate)



#### Ordering Information (Note 4)

Part Number	Paakaga	Packing			
Fart Number	Package	Qty.	Carrier		
DMC10H220LSD-13	SO-8	2,500	Tape & Reel		

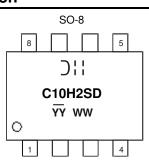
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

# **Marking Information**



DMC10H220LSD Document number: DS43379 Rev. 2 - 2



#### Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Q1	Q2	Unit		
Drain-Source Voltage	VDSS	100	-100	V		
Gate-Source Voltage			V <sub>GSS</sub>	±20	±20	V
Continuous Drain Current (Note 6) N-Channel: V <sub>GS</sub> = 10V P-Channel: V <sub>GS</sub> = -10V	Steady State	TA = +25°C TA = +70°C	ID	1.7 1.4	-1.7 -1.4	A
Maximum Body Diode Forward Current (Note 6)			ls	1.7	-1.7	A
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			ldм	9	-13	A
Avalanche Current, L = 0.1mH			las	3.2	-11	A
Avalanche Energy, L = 0.1mH			Eas	0.5	6	mJ

#### Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		PD	1	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R <sub>0JA</sub>	110	°C/W
Total Power Dissipation (Note 6)		PD	1.5	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	Reja	80	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

# Electrical Characteristics N-Channel Q1 (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BVDSS	100		_	V	$V_{GS} = 0V, I_D = 250 \mu A$	
Zero Gate Voltage Drain Current	IDSS	_	_	1	μA	$V_{DS} = 100V, V_{GS} = 0V$	
Gate-Source Leakage	lgss			±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	1	—	3	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
Static Drain-Source On-Resistance	Decient		170	220	mΩ	VGS = 10V, ID = 1.6A	
Static Drain-Source On-Resistance	RDS(ON)	_	210	260	11152	$V_{GS} = 4.5V, I_D = 1.3A$	
Diode Forward Voltage	Vsd	_	0.7	1.2	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = 1.1A	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	_	340			Vbs = 50V, Vgs = 0V f = 1MHz	
Output Capacitance	Coss		18	_	pF		
Reverse Transfer Capacitance	Crss	_	12	_			
Gate Resistance	Rg		2.1	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	_	4.1	_			
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg	_	8.3	_	nC		
Gate-Source Charge	Qgs	_	1.5	_	no	$V_{DS} = 50V, I_{D} = 1.6A$	
Gate-Drain Charge	Qgd	_	2	_			
Turn-On Delay Time	td(ON)	_	6.8	_			
Turn-On Rise Time	tR	_	8.2	_		$\label{eq:VDS} \begin{array}{l} V_{DS}=50V, \ V_{GS}=4.5V, \\ R_G=6.8\Omega, \ I_D=1A \end{array}$	
Turn-Off Delay Time	tD(OFF)	_	7.9		ns		
Turn-Off Fall Time	t⊧	_	3.6		1		
Body Diode Reverse Recovery Time	t <sub>RR</sub>	_	17		ns		
Body Diode Reverse Recovery Charge	QRR	_	9.8	—	nC	l⊧ = 1.1A, di/dt =100A/μs	

 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to product testing. Notes:



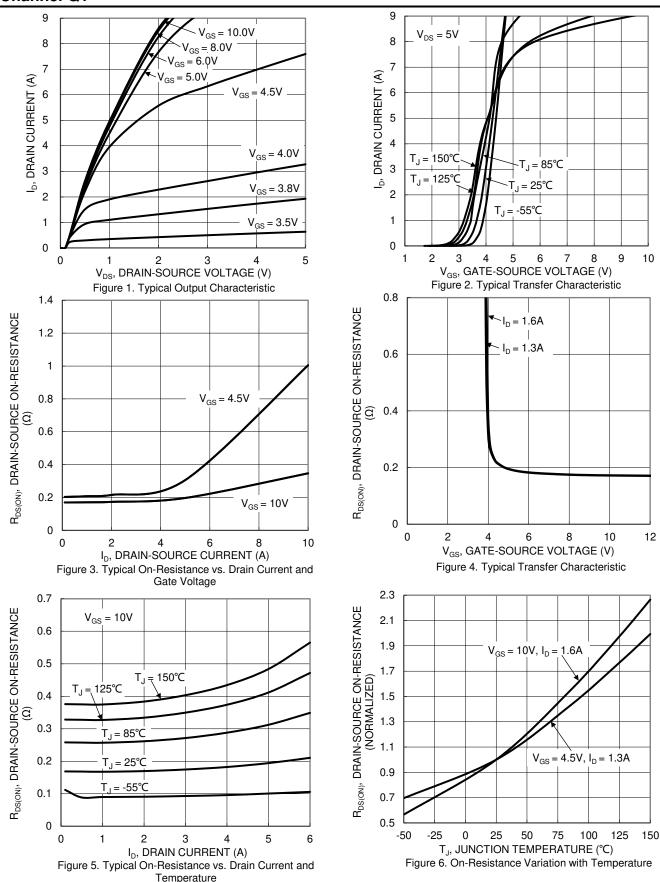
# Electrical Characteristics P-Channel Q2 (@T<sub>A</sub> = +25°C, unless otherwise specified.)

		-		-		-	
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BVDSS	-100		_	V	$V_{GS} = 0V, I_D = -250 \mu A$	
Zero Gate Voltage Drain Current	IDSS		—	-1	μA	$V_{DS} = -100V, V_{GS} = 0V$	
Gate-Source Leakage	Igss		_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	-1.0	_	-3.0	V	$V_{DS} = V_{GS}, I_D = -250 \mu A$	
Static Drain-Source On-Resistance	<b>B</b> RO(ON)		200	250	mΩ	VGS = -10V, ID = -1A	
	RDS(ON)	—	210	300	11152	$V_{GS} = -4.5V, I_D = -1A$	
Diode Forward Voltage	V <sub>SD</sub>	_	-0.9	-1.2	V	$V_{GS} = 0V, I_{S} = -1A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss		1030	_		V <sub>DS</sub> = -50V, V <sub>GS</sub> = 0V, f = 1.0MHz	
Output Capacitance	Coss		33	_	pF		
Reverse Transfer Capacitance	Crss		24	_			
Gate Resistance	Rg		13	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
Total Gate Charge (V <sub>GS</sub> = -4.5V)	Qg		8.4	_			
Total Gate Charge (V <sub>GS</sub> = -10V)	Qg		17.5	_	nC	V <sub>DS</sub> = -60V, I <sub>D</sub> = -1A	
Gate-Source Charge	Qgs		2.8	_	10		
Gate-Drain Charge	Qgd	_	3.2	_			
Turn-On Delay Time	td(on)	_	9.1	_		$V_{DD} = -50V, R_G = 9.1\Omega, I_D = -1A$	
Turn-On Rise Time	tR	_	14.9	_			
Turn-Off Delay Time	tD(OFF)	_	57.4	_	ns		
Turn-Off Fall Time	tF		34.4	_			
Body Diode Reverse Recovery Time	trr		25.2	_	ns	$V_{GS} = 0V$ , $I_{S} = -1A$ , $di/dt = 100A/\mu s$	
Body Diode Reverse Recovery Charge	Q <sub>RR</sub>		24.5	_	nC	$V_{GS} = 0V, I_S = -1A, di/dt = 100A/\mu s$	

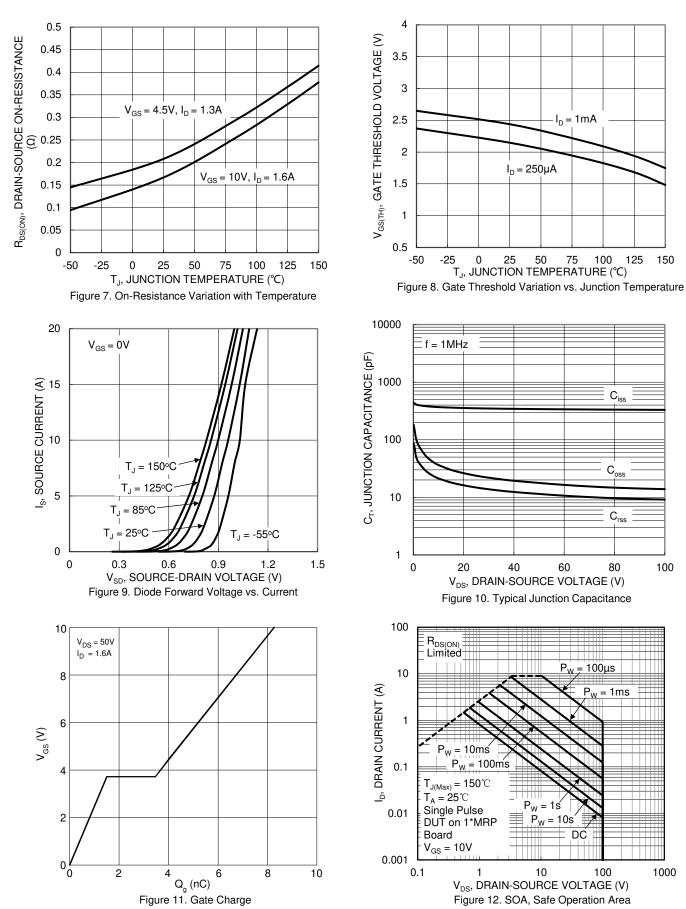
Notes:7. Short duration pulse test used to minimize self-heating effect.8. Guaranteed by design. Not subject to product testing.



#### N-Channel Q1

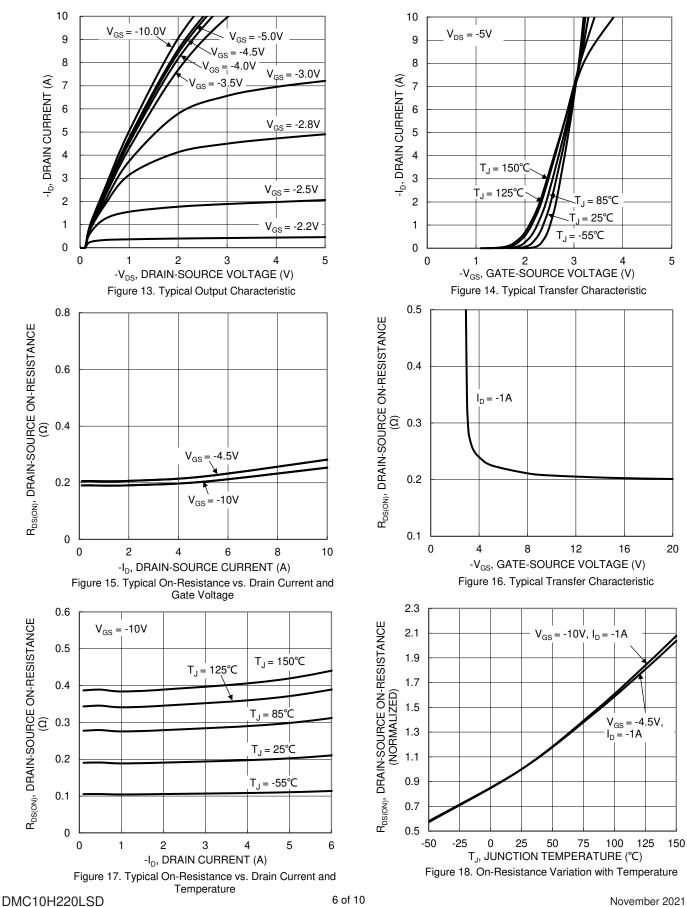








## P-Channel Q2

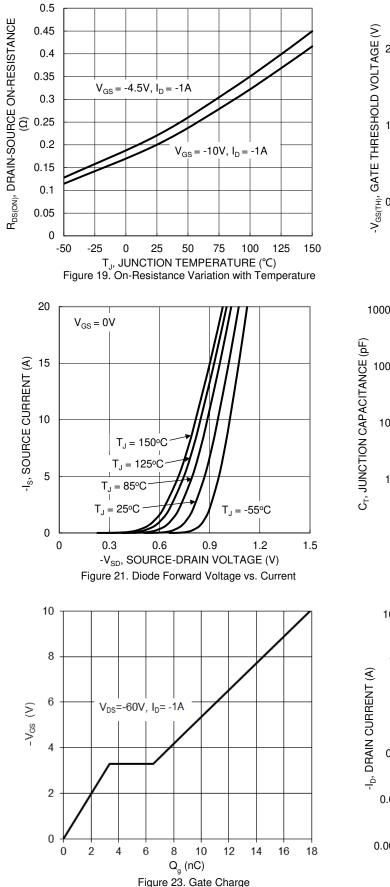


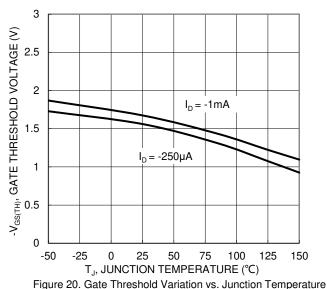
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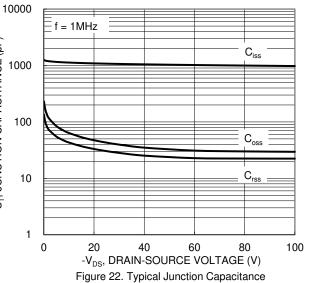
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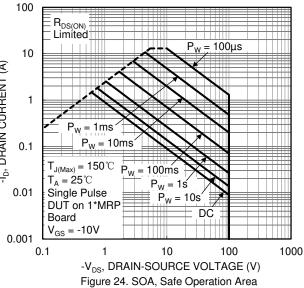
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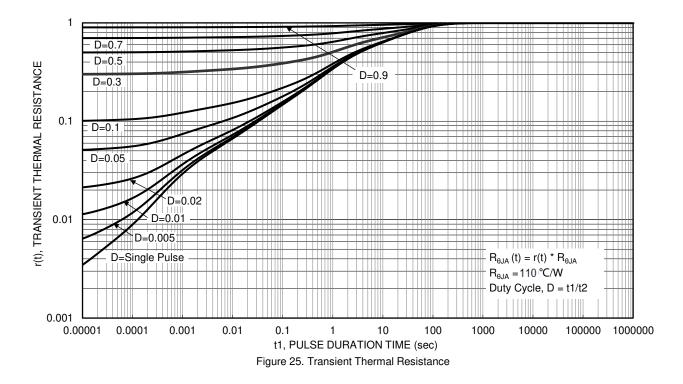






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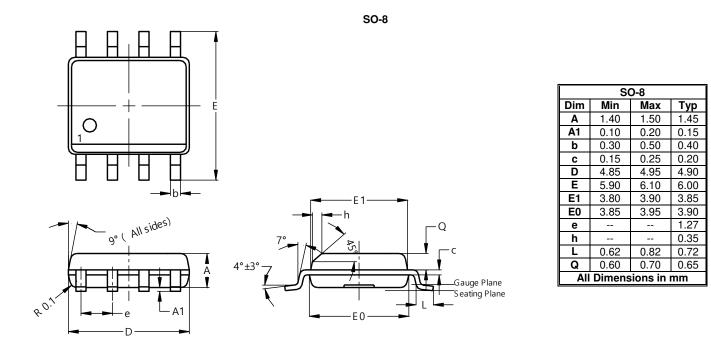






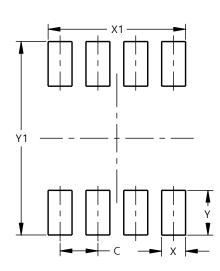
### **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.



## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	1.27
Х	0.802
X1	4.612
Y	1.505
Y1	6.50

SO-8



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